



800V Super-junction Power MOSFET

Description

800V Super-junction Power MOSFET

Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle and pioneered. The Multi-EPI SJ MOSFET provide an extremely fast and robust body diode. Also provide an extremely low switching, communication and conduction losses device with highest robustness make especially resonant switching applications more reliable, more efficient, lighter and cooler, designed by Wuxi Unigroup Microelectronics Company.

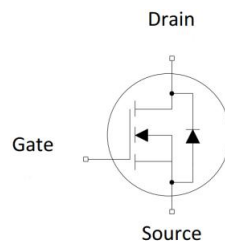
Features

- Ultra-fast body diode
- Very low FOM $R_{DS(on)} \times Q_g$
- Easy to use/drive
- 100% avalanche tested
- RoHS compliant

Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- LLC Half-bridge
- Low Power Chargers and Adapters

TO-247



Device Marking and Package Information

| Device | Package | Marking |
|--------------|---------|-----------|
| TPW80R200MFD | TO-247 | 80R200MFD |

Key Performance Parameters

| Parameter | Value | Unit |
|----------------------|-------|------------|
| $V_{DS} @ T_{j,max}$ | 850 | V |
| $R_{DS(on),max}$ | 0.2 | Ω |
| $Q_{g,typ}$ | 56.7 | nC |
| I_D | 23 | A |
| $I_{D,pulse}$ | 69 | A |
| $E_{OSS} @ 400V$ | 4.9 | μJ |
| Body Diode di_f/dt | 900 | A/ μs |
| t_{rr} | 149.5 | ns |
| Q_{rr} | 0.98 | μC |
| I_{rrm} | 11.5 | A |



| Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted | | | | |
|---|---------------------------|----------------|------------------|------------------|
| Parameter | | Symbol | Values | Unit |
| Continuous Drain Current | $T_C = 25^\circ\text{C}$ | I_D | 23 | A |
| | $T_C = 100^\circ\text{C}$ | | 13.8 | |
| Pulsed Drain Current | (note1) | $I_{D,pulse}$ | 69 | A |
| Gate-Source Voltage | | V_{GSS} | $\pm 30\text{V}$ | V |
| Single Pulse Avalanche Energy | (note2) | E_{AS} | 1125 | mJ |
| Repetitive Avalanche Energy | (note2) | E_{AR} | 27.8 | mJ |
| Avalanche Current | | I_{AR} | 4.6 | A |
| MOSFET dv/dt Ruggedness, $V_{DS} = 0 \dots 480\text{V}$ | | dv/dt | 50 | V/ns |
| Power Dissipation For TO-247 | | P_D | 215 | W |
| Continuous Diode Forward Current | | I_S | 23 | A |
| Diode Pulsed Current | (note1) | $I_{S,pulse}$ | 69 | |
| Reverse Diode dv/dt | (note3) | dv/dt | 50 | V/ns |
| Maximum Diode Commutation Speed | (note3) | di/dt | 900 | A/ μs |
| Operating Junction and Storage Temperature Range | | T_J, T_{stg} | -55~+150 | $^\circ\text{C}$ |

| Thermal Resistance For TO-247 | | | |
|---|------------|-------|---------------------------|
| Parameter | Symbol | Value | Unit |
| Thermal Resistance, Junction-to-Case | R_{thJC} | 0.59 | $^\circ\text{C}/\text{W}$ |
| Thermal Resistance, Junction-to-Ambient | R_{thJA} | 62.5 | |



| Electrical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted | | | | | | |
|--|---------------|---|-------|--------|-----------|---------------|
| Parameter | Symbol | Test Conditions | Value | | | Unit |
| | | | Min. | Typ. | Max. | |
| Static Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu\text{A}$ | 800 | -- | -- | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 800V, V_{GS} = 0V, T_J = 25^\circ\text{C}$ | -- | -- | 10 | μA |
| Gate-Source Leakage Current | I_{GSS} | $V_{GS} = \pm 30V$ | -- | -- | ± 100 | nA |
| Gate-Source Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$ | 3 | -- | 5 | V |
| Drain-Source On-State-Resistance | $R_{DS(on)}$ | $V_{GS} = 10V, I_D = 11.5A$ | -- | 0.18 | 0.2 | Ω |
| Gate Resistance | R_G | $f = 1.0\text{MHz}$ open drain | -- | 1.6 | -- | Ω |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | C_{iss} | $V_{GS} = 0V,$ $V_{DS} = 100V$ $f = 1.0\text{MHz}$ | -- | 2441.8 | -- | pF |
| Output Capacitance | C_{oss} | | -- | 59.94 | -- | |
| Reverse Transfer Capacitance | C_{rss} | | -- | 4.93 | -- | |
| Total Gate Charge | Q_g | $V_{DD} = 640V,$ $I_D = 23A,$ $V_{GS} = 10V$ | -- | 56.7 | -- | nC |
| Gate-Source Charge | Q_{gs} | | -- | 12.2 | -- | |
| Gate-Drain Charge | Q_{gd} | | -- | 21.4 | -- | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD} = 400V$ $I_D = 23A$ $R_G = 25\Omega$ | -- | 56.7 | -- | ns |
| Turn-on Rise Time | t_r | | -- | 46.2 | -- | |
| Turn-off Delay Time | $t_{d(off)}$ | | -- | 203 | -- | |
| Turn-off Fall Time | t_f | | -- | 59 | -- | |
| Drain-Source Body Diode Characteristics | | | | | | |
| Body Diode Forward Voltage | V_{SD} | $T_J = 25^\circ\text{C}, I_{SD} = 12A, V_{GS} = 0V$ | -- | 0.9 | 1.5 | V |
| Reverse Recovery Time | t_{rr} | $V_R = 400V$ $I_F = 23A$ $di_F/dt = 100A/\mu\text{s}$ | -- | 149.5 | -- | ns |
| Reverse Recovery Charge | Q_{rr} | | -- | 0.98 | -- | μC |
| Peak Reverse Recovery Current | I_{rrm} | | -- | 11.5 | -- | A |

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. $I_D = 10A, V_{DD} = 50V, R_G = 25\Omega, \text{Starting } T_J = 25^\circ\text{C}$
3. Identical low side and high side switch with identical R_G



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

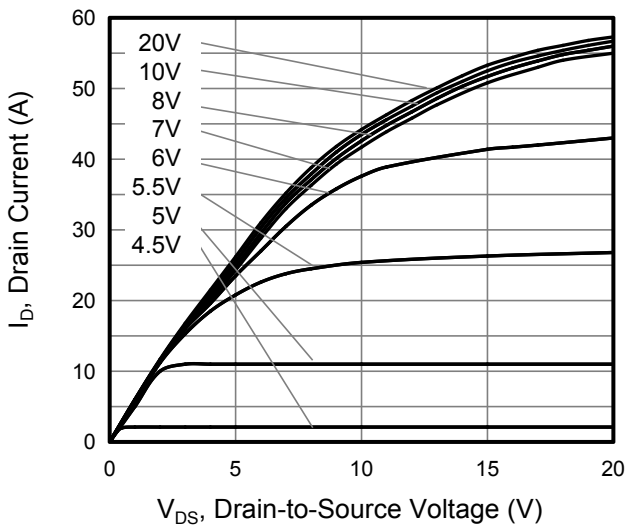


Figure 2. Transfer Characteristics

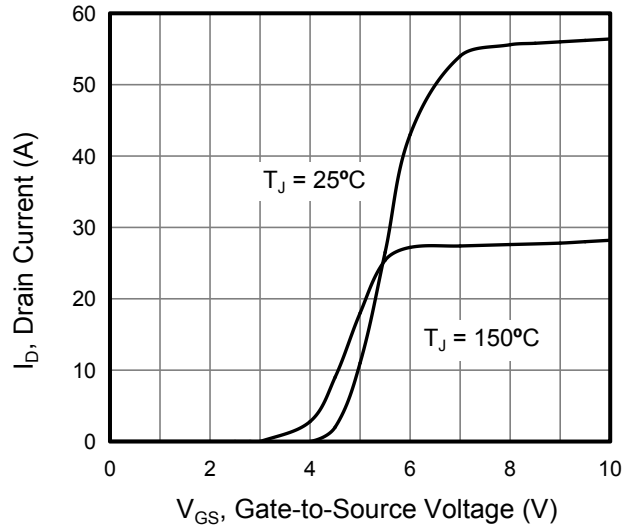


Figure 3. On-Resistance vs. Drain Current

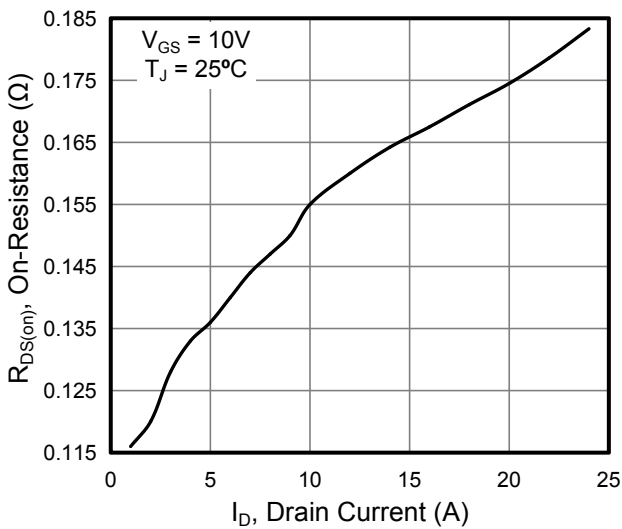


Figure 4. Capacitance

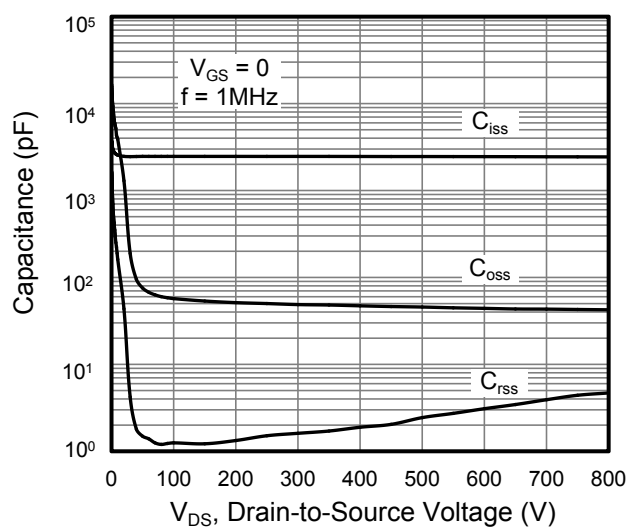


Figure 5. Gate Charge

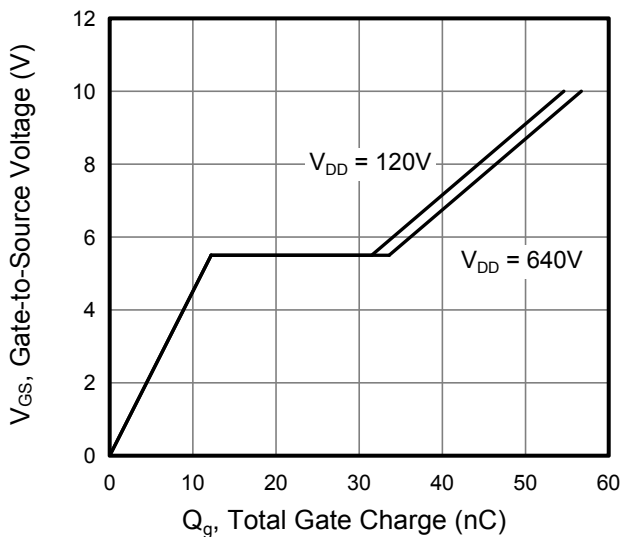
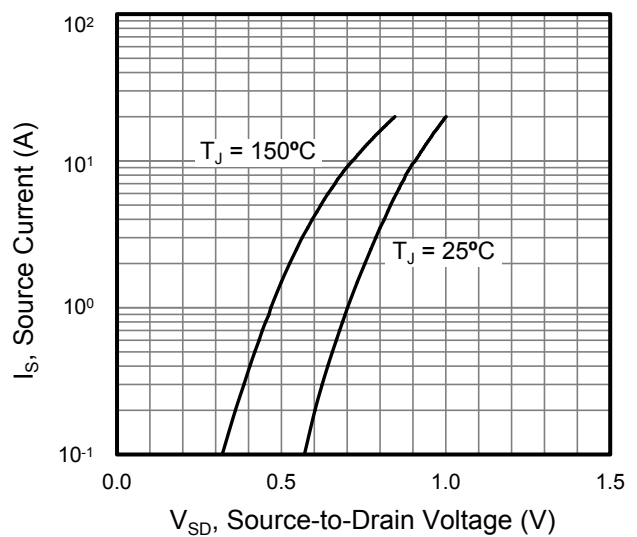


Figure 6. Body Diode Forward Voltage





Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. On-Resistance vs. Temperature

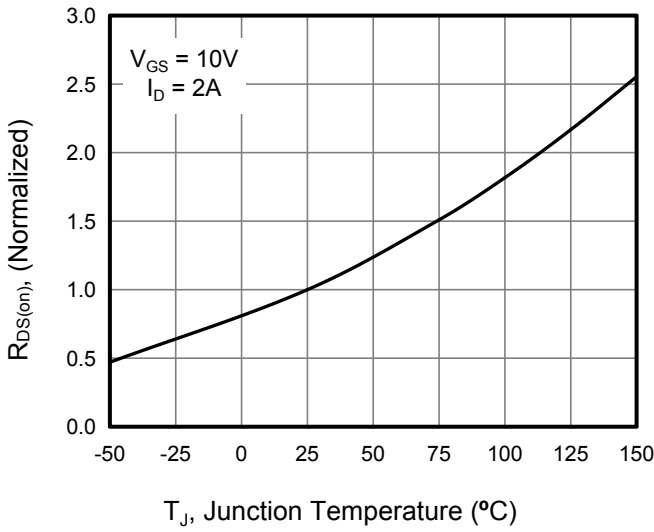


Figure 8. Breakdown Voltage vs. Junction Temperature

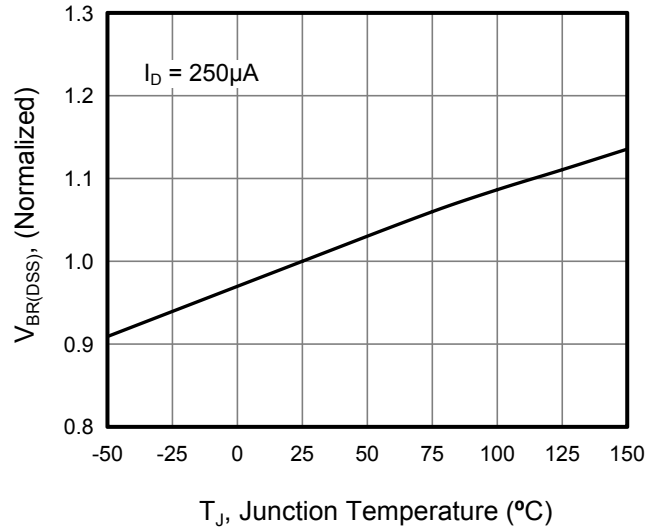


Figure 9. Transient Thermal Impedance For TO-247

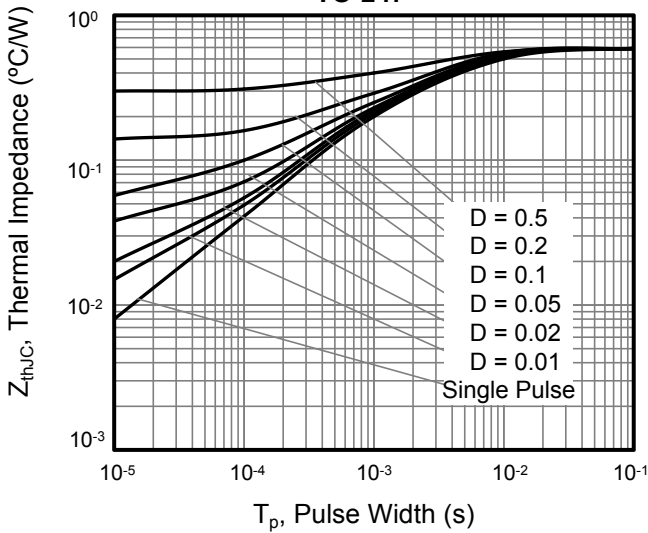


Figure 10. Safe Operation Area For TO-247

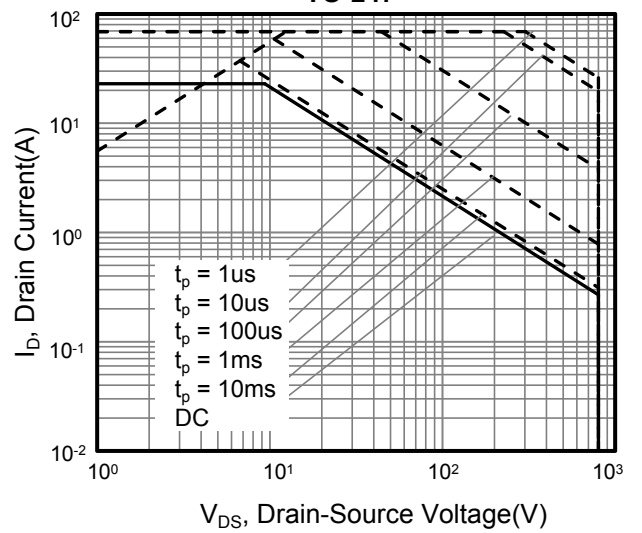


Figure 11. Typ. Coss Stored Energy

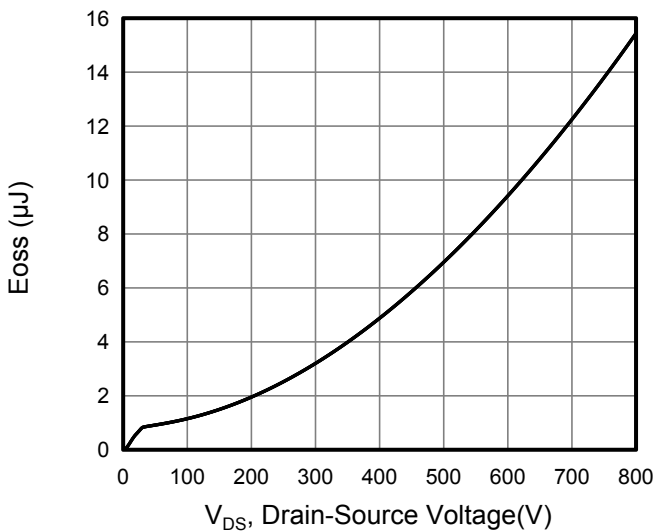




Figure A: Gate Charge Test Circuit and Waveform

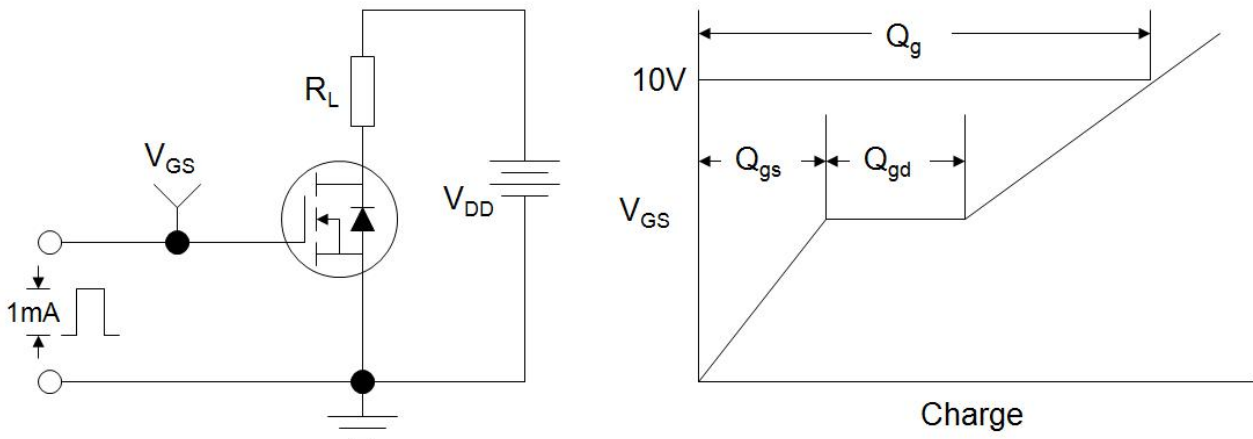


Figure B: Resistive Switching Test Circuit and Waveform

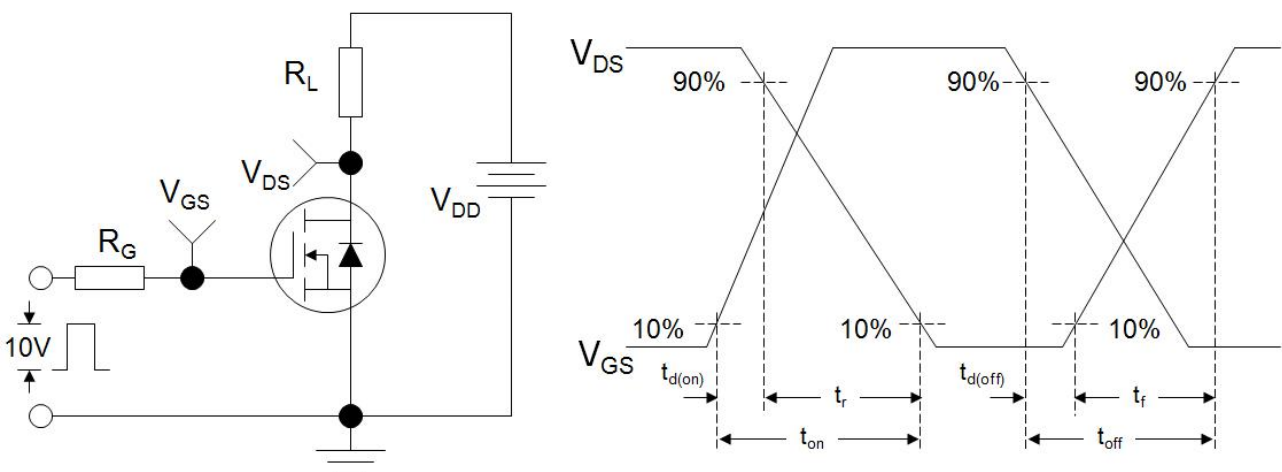
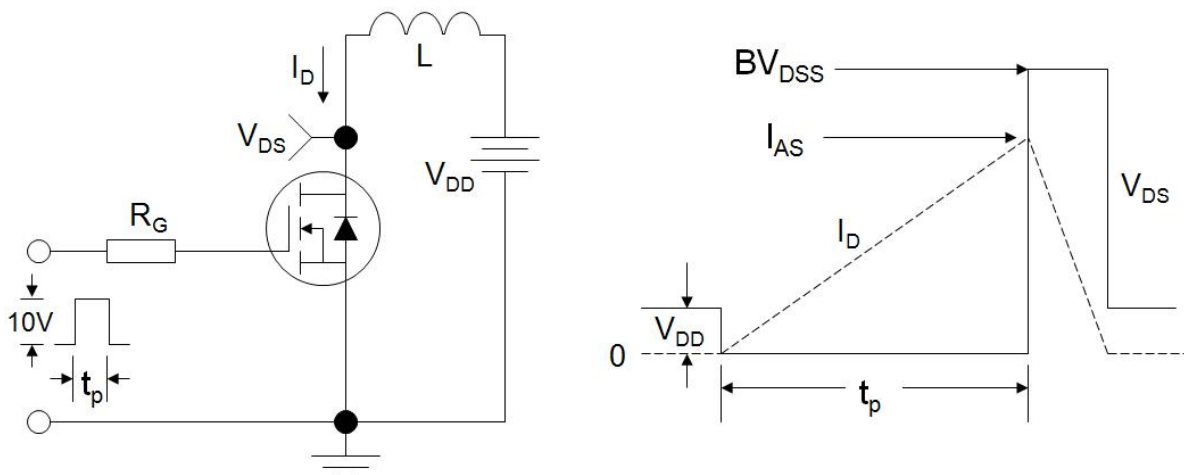
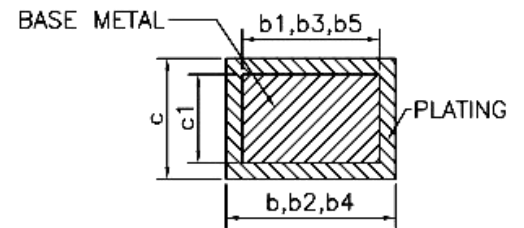
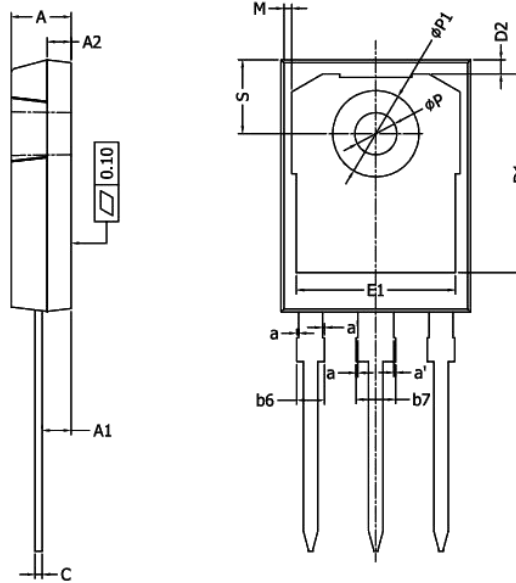
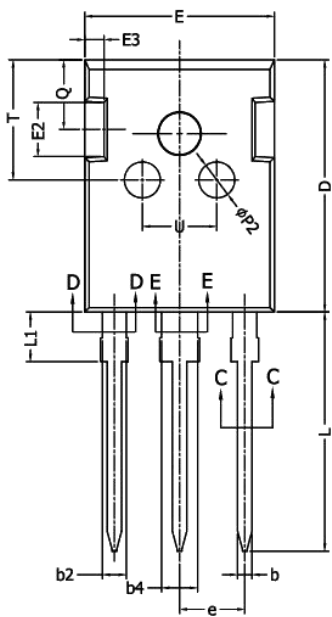


Figure C: Unclamped Inductive Switching Test Circuit and Waveform





TO-247



| SYMBOL | MIN | NOM | MAX |
|--------|-----------|-------|-------|
| A | 4.90 | 5.00 | 5.10 |
| A1 | 2.31 | 2.41 | 2.51 |
| A2 | 1.90 | 2.00 | 2.10 |
| a | 0 | --- | 0.15 |
| a' | 0 | --- | 0.15 |
| b | 1.16 | --- | 1.26 |
| b1 | 1.15 | 1.2 | 1.22 |
| b2 | 1.96 | --- | 2.06 |
| b3 | 1.95 | 2.00 | 2.02 |
| b4 | 2.96 | --- | 3.06 |
| b5 | 2.96 | 3.00 | 3.02 |
| b6 | --- | --- | 2.25 |
| b7 | --- | --- | 3.25 |
| c | 0.59 | --- | 0.66 |
| c1 | 0.58 | 0.60 | 0.62 |
| D | 20.90 | 21.00 | 21.10 |
| D1 | 16.25 | 16.55 | 16.85 |
| D2 | 1.05 | 1.17 | 1.35 |
| E | 15.70 | 15.80 | 15.90 |
| E1 | 13.10 | 13.30 | 13.50 |
| E2 | 4.40 | 4.50 | 4.60 |
| E3 | 2.40 | 2.50 | 2.60 |
| e | 5.436 BSC | | |
| L | 19.80 | 19.92 | 20.10 |
| L1 | --- | --- | 4.30 |
| M | 0.35 | --- | 0.95 |
| P | 3.40 | 3.50 | 3.60 |
| P1 | 7.00 | --- | 7.40 |
| P2 | 2.40 | 2.50 | 2.60 |
| Q | 5.60 | --- | 6.00 |
| S | 6.05 | 6.15 | 6.25 |
| T | 9.80 | --- | 10.20 |
| U | 6.00 | --- | 6.40 |



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